



PRODUCT DATASHEET



- PCB / CHIP LED
- 1209 Series
 Red (640nm) / Green

Red (640nm) / Gree (570nm)



RóHS Compliant





- Package: PCB / CHIP LED
- Forward Current: 20/20mA*
- Forward Voltage (typ.): 2.0/2.0V
- Luminous Intensity (typ.): 60/40mcd @20mA
- Colour: Red/Green
- Wavelength: 640/570nm
- Viewing angle: 60/60°
- Materials:
 - Die: AlGaInP/AlGaInP
 - Resin: Epoxy (Water Clear)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - Wavelength
- Soldering methods: Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: : 8mm tape with 1500/reel, ø180mm (7")

* In the order of Red/Green.



APPLICATIONS:

- Indicator
- Dashboard
- 3C Application
- Backlighting
- Decoration Lighting

1209 Series

N0D11S90



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30/30*	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125/125	mA
Reverse Current @5V	I _R	10/10	μΑ
Power Dissipation	P _D	75/75	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{stg}	-40~+85	°C

1. * In the order of Red/Green.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	$V_{\rm F}$	1.7/1.7*	2.0/2.0	2.5/2.5	V	I _F =20mA
Luminous Intensity	I_V	40/30	60/40	80/55	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	630/565	640/570	650/576	nm	I _F =20mA
Peak Wavelength	λ_{P}		650/570		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		20/17		nm	I _F =20mA
Viewing Angle	20 _{1/2}		60/60		deg	I _F =20mA

1. * In the order of Red/Green.

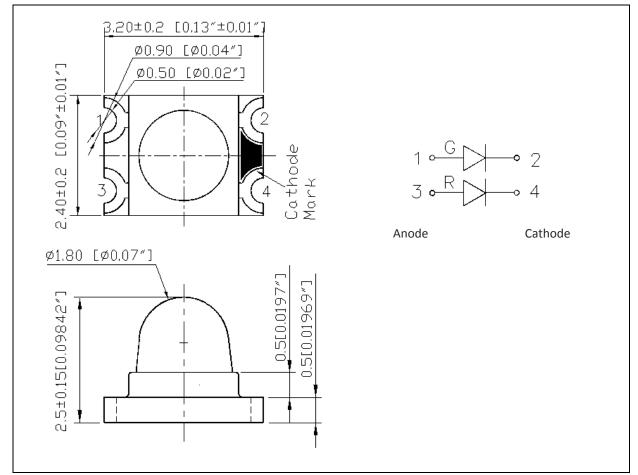
2. Luminous intensity (I_v) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%

3. IS standard testing



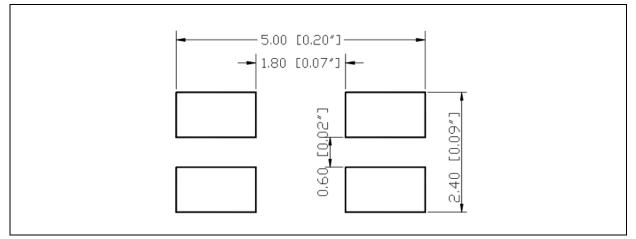
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA$):

	Code	Min.	Max.	Unit
Red	В	1.7	2.5	V
Green	В	1.7	2.5	V

Luminous Intensity Classifications (I_F = 20mA):

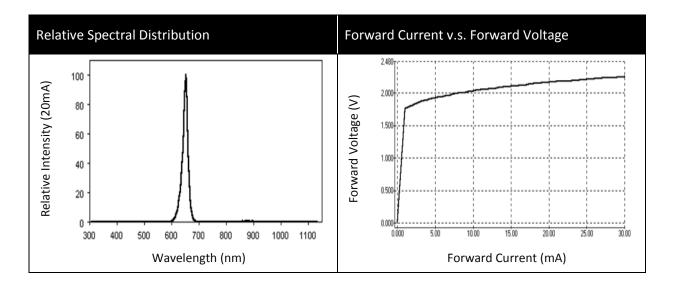
	Code	Min.	Max.	Unit
	E	40	50	
Red	F	50	63	mcd
	G	63	80	
	D	30	40	
Green	E	40	50	mcd
	F	50	63	

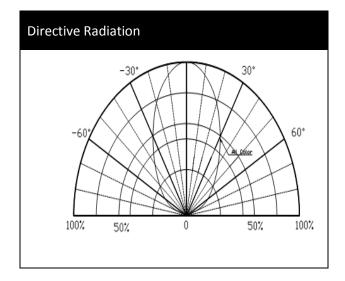
Wavelength Classifications ($I_F = 20mA$):

	Code	Min.	Max.	Unit
Red	Н	630	635	
	I	635	640	
	J	640	645	nm
	К	645	650	
Green	D	565	568	
	E	568	572	nm
	F	572	576	



ELECTRO-OPTICAL CHARACTERISTICS (GREEN):

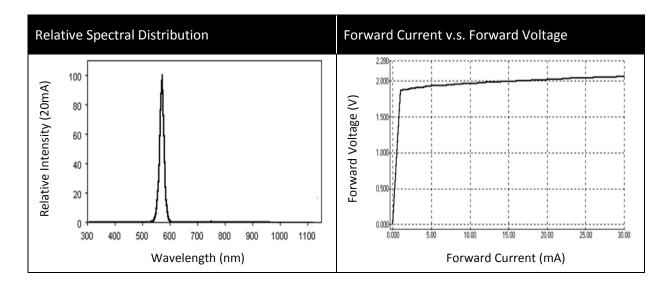


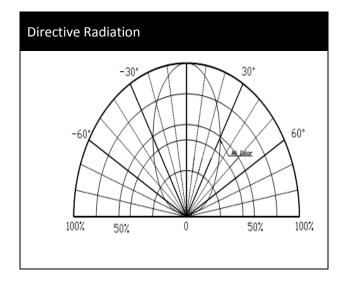


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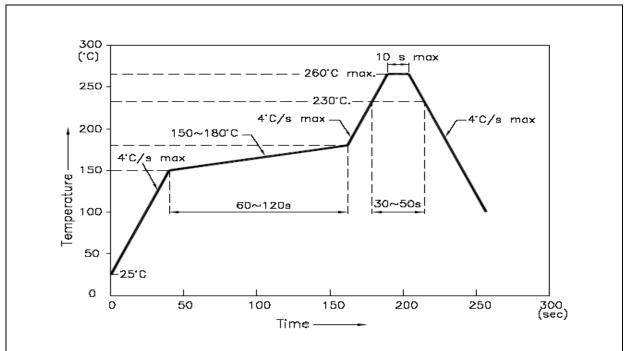
ELECTRO-OPTICAL CHARACTERISTICS (BLUE):







RECOMMENDED SOLDERING PROFILE:



Reflow Solder:

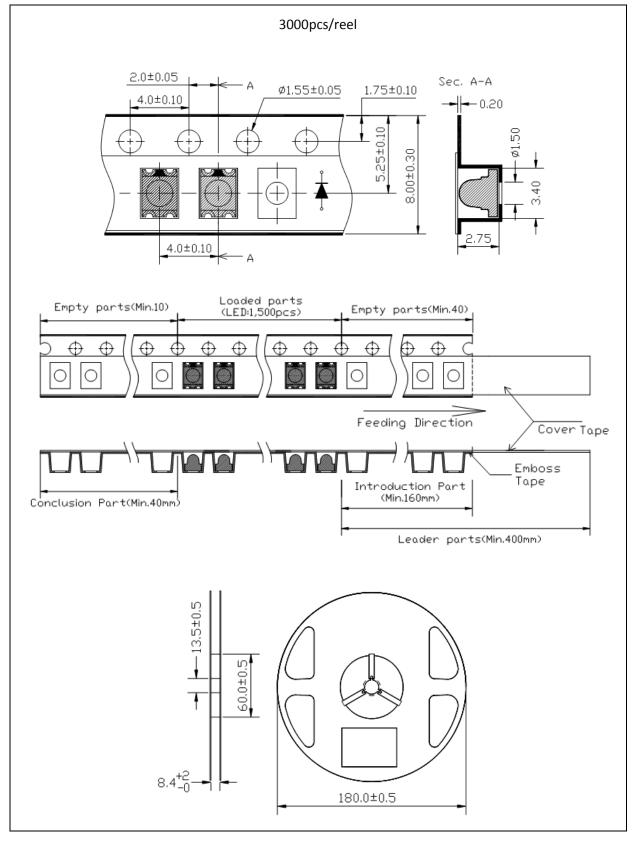
Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light Blue) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

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Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	07/08/2014	Datasheet set-up.